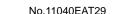


LED Driver s for LCD Backlights

Mulitifunction Backlight LED Driver for Small LCD Panels (Charge Pump Type)



Description

BD6088GUL

BD6088GUL is "Intelligent LED Driver" that is the most suitable for the cellular phone.

It has 6LED driver for LCD Backlight and GPO 4 port.

It has ALC function, that is "Low Power Consumption System" realized.

It can be developed widely from the model high End to the model Low End.

As it has charge pump circuit for DCDC, it is no need to use coils, and it contributes to small space.

VCSP50L3(3.50mm×3.50mm 0.5mm space)

It adopts the very thin CSP package that is the most suitable for the slim phone.

Functions

1) Total 6LEDs driver for LCD Backlight

It have 4LEDs (it can select 4LED or 3LED) for exclusire use of Main and 2LEDs which can

chose independent control or a main allotmert by resister setting.

"Main Group" can be controlled by Auto Luminous Control (ALC) system.

"Main Group" can be controlled by external PWM signal.

ON/ off and a setup of electric current are possible at the time of the independent control by the independence.

2) Ambient Light sensor interface

Main backlight can be controlled by ambient brightness.

Photo Diode, Photo Transistor, Photo IC(Linear/Logarithm) can be connected.

Bias source for ambient light sensor, gain and offset adjustment are built in.

LED driver current as ambient level can be customized.

3) Charge Pump DC/DC for LED driver

It has x1/x1.5/ x2 mode that will be selected automatically.

The most suitable voltage up magnification is controlled automatically by LED port voltage.

Output voltage fixed mode function loading (3.9V/4.2V/4.5V/4.8V)

Soft start functions, Over voltage protection (Auto-return type), Over current protection (Auto-return type) Loading

4) GPO 4 Port

Open Drain output and slope control loading

- 5) Thermal shutdown
- 6) I²C BUS FS mode(max 400kHz)

Absolute Maximum Ratings (Ta=25 °C)

Parameter	Symbol	Ratings	Unit
Maximum voltage	VMAX	7	V
Power Dissipation	Pd	1380 ^{(note}	mW
Operating Temperature Range	Topr	-30 ~ +85	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C

note) Power dissipation deleting is 11.04mW/ °C, when it's used in over 25 °C. (It's deleting is on the board that is ROHM's standard)

Operating conditions (VBAT≥VIO, Ta=-35~85 °C)

Parameter	Symbol	Ratings	Unit
VBAT input voltage	VBAT	2.7 ~ 5.5	V
VIO pin voltage	VIO	1.65 ~ 3.3	V

^{*}This chip is not designed to protect itself against radioactive rays.

^{*}This material may be changed on its way to designing.

^{*}This material is not the official specification.

● Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=2.6V)

Parameter.	C !		Limits		119	O = = = state
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
[Circuit Current]				1		1
VBAT Circuit current 1	IBAT1	-	0.1	3.0	μΑ	RESETB=0V, VIO= 0V
VBAT Circuit current 2	IBAT2	-	0.5	3.0	μΑ	RESETB=0V, VIO=2.6V
VBAT Circuit current 3	IBAT3	-	61	65	mA	DC/DC x1 mode, Io=60mA VBAT=4.0V
VBAT Circuit current 4	IBAT4	-	92	102	mA	DC/DC x1.5 mode, lo=60mA VBAT=3.6V
VBAT Circuit current 5	IBAT5	-	123	140	mA	DC/DC x2 mode, lo=60mA VBAT=2.7V
VBAT Circuit current 6	IBAT6	-	0.25	1.0	mA	ALC Operating ALCEN=1, AD cycle=0.5s setting Except sensor current
[LED Driver]						1
LED current Step (Setup)	ILEDSTP1		128		Step	LED1~6
LED current Step (At slope)	ILEDSTP2		256		Step	LED1~6
LED Maximum setup current	IMAXWLED	-	25.6	-	mA	LED1~6
LED current accuracy	IWLED	-7%	15	+7%	mA	I _{LED} =15mA setting, VLED=1.0V
LED current Matching	ILEDMT	-	-	4	%	Between LED1~6 at VLED=1.0V, ILED=15mA
LED OFF Leak current	ILKLED	-	-	1.0	μΑ	VLED=4.5V
【DC/DC(Charge Pump)】			1	1		1
Output Voltage 1	VoCP1	-	Vf+0.2	Vf+0.25	V	Vf is forward direction of LED
		3.705	3.9	4.095	V	Fixation Voltage Output
Output Voltage 2	VoCP2	3.99	4.2	4.41	V	Modelo=60mA
		4.275 4.56	4.5 4.8	4.725 5.04	V	VBAT≧3.2V
Drive ability	IOUT	-	-	150	mA	VBAT≥3.2V, VOUT=3.9V
Switching frequency	fosc	0.8	1.0	1.2	MHz	
Over Voltage Protection detect voltage	OVP	-	6.0	6.5	V	
Over Current Protection detect Current	OCP	-	250	375	mA	VOUT=0V
[Sensor Interface]			1	'		
SBIAS Output Voltage	VoS	2.85 2.47	3.0 2.6	3.15 2.73	V	Io=200μA Io=200μA
SBIAS Maximum Output current	IomaxS	30	-	-	mA	Vo=2.6V setting
SBIAS Discharge resister at OFF	ROFFS	-	1.0	1.5	kΩ	
SSENS Input range	VISS	0	-	VoS× 255/256	V	
ADC resolution	ADRES		8		bit	
ADC integral calculus non-linearity	ADINL	-3	-	+3	LSB	

● Electrical Characteristics (Unless otherwise specified, Ta=25°C, VBAT=3.6V, VIO=2.6V)

SDA, SCL] (I ² C Interface) Lievel input voltage	`andition	Condition	Unit		Limits		Symbol	Parameter			
Lievel input voltage	ondition	Condition	Unit	Max.	Тур.	Min.	Symbol				
Lievel input voltage				1				【SDA, SCL】 (I ² C Interface)			
Hevel input voltage			V	VIO	-		VILI	L level input voltage			
Lievel output voltage			V		-	VIO	VIHI	H level input voltage			
Input Voltage			V	-	-		Vhysl	Hysteresis of Schmitt trigger input			
Input current Input - - μA = 0.1xVIO~0.9xVI		SDA Pin, IOL=3 mA	V	0.3	-	0	VOLI	L level output voltage			
Lievel input voltage		Input Voltage = 0.1xVIO~0.9xVIO	μΑ	1	-	-	linl	<u> </u>			
Lievel input voltage				1				【RESETB】 (CMOS Input Pin)			
Input current Input VIPK VIO - +0.3 V Input Voltage = 0.1xVIO ~ 0.9xVI			V	VIO	-		VILR	L level input voltage			
Input current Infine - - μA = 0.1xVIO~0.9xVI			V		-		VIHR	H level input voltage			
Lievel input voltage		Input Voltage = 0.1xVIO~0.9xVIO	μΑ	1	-	-	linR	•			
H level input voltage		I		1 1				【WPWMIN】 (NMOS Input Pin)			
Input Current Input Voltage VIFIA 1.4 - +0.3 V			V		-	-0.3	VILA	L level input voltage			
PWM Input Current InfiA - -			V		-	1.4	VIHA	H level input voltage			
COUTCNT] (Pull-down resistance NMOS Input Pin) L level input voltage	, ∼0.9×VBAT	Input Voltage = 0.1×VBAT~0.9×VBAT	μΑ	1	-	-	linA	•			
L level input voltage VILA -0.3 - 0.3 V H level input voltage VIHA 1.4 - VBAT +0.3 V Input Current IinA - 3.6 10 μ Vin=1.8V IOUT1~4] (NMOS Open Drain Output Pin) L level output voltage VOLG - 0.3 V IOL=10mA Output Leak current ILKG - 1.0 μ Vout=3.6V IGC1, GC2] (Sensor Gain Control CMOS Output Pin) L level output voltage VOLS - 0.2 V IOL=1mA H level output voltage VOHS VOS -0.2 - V IOH=1mA IKBLT] (Key Back Light Control CMOS Output Pin) L level output voltage VOLK - 0.2 V IOH=1mA	า	WPWMIN Pin	μs	-	-			width			
H level input voltage				1		in)	NMOS Input P	[OUTCNT] (Pull-down resistance N			
H level input voltage			V		-	-0.3	VILA	L level input voltage			
[OUT1~4] (NMOS Open Drain Output Pin) L level output voltage			V		-	1.4	VIHA	H level input voltage			
L level output voltage		Vin=1.8V	μΑ	10	3.6	-		•			
Output Leak current ILKG 1.0 µA Vout=3.6V [GC1, GC2] (Sensor Gain Control CMOS Output Pin) L level output voltage VOLS 0.2 V IOL=1mA H level output voltage VOHS VOS V IOH=1mA [KBLT] (Key Back Light Control CMOS Output Pin) L level output voltage VOHK 0.2 V IOL=1mA		T		1 1			utput Pin)	【OUT1∼4】(NMOS Open Drain O			
[GC1, GC2] (Sensor Gain Control CMOS Output Pin) L level output voltage		IOL=10mA	V	0.3	-	-	VOLG	L level output voltage			
L level output voltage VOLS - 0.2 V IOL=1mA H level output voltage VOHS VOS -0.2 - V IOH=1mA I(KBLT) (Key Back Light Control CMOS Output Pin) L level output voltage VOLK - 0.2 V IOL=1mA		Vout=3.6V	μΑ	1.0	-	-		•			
H level output voltage VOHS VOS -0.2 - V IOH=1mA [KBLT] (Key Back Light Control CMOS Output Pin) L level output voltage VOLK VIO VIO VIO VIO VIO VIO VIO VI		I		1 1		t Pin)	CMOS Outpu	[GC1, GC2] (Sensor Gain Control			
Compared to the control of the con		IOL=1mA	V	0.2	-		VOLS	L level output voltage			
L level output voltage VOLK 0.2 V IOL=1mA		IOH=1mA	V	-	-	-0.2		•			
H level cutnut voltage VOHK VIO V IOH-1mA		I		1		in)	IOS Output P	【KBLT】 (Key Back Light Control C			
		IOL=1mA	V	0.2	-	-	VOLK	L level output voltage			
H level output voltage VORK -0.2 V IOH=1111A		IOH=1mA	V	-	-		VOHK	H level output voltage			
Pull-downregistance RPUDK - 1.0 2.0 MΩ Vin=3.3V		Vin=3.3V	МΩ	2.0	1.0	-	RPUDK	Pull-downregistance			

●Block Diagram / Application Circuit example 1

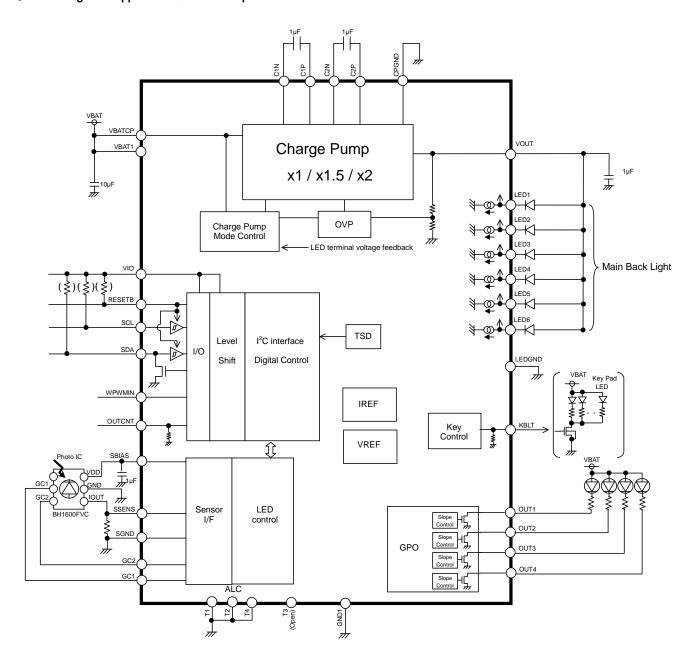


Fig.1 Block Diagram / Application Circuit example 1

●Block Diagram / Application Circuit example 2

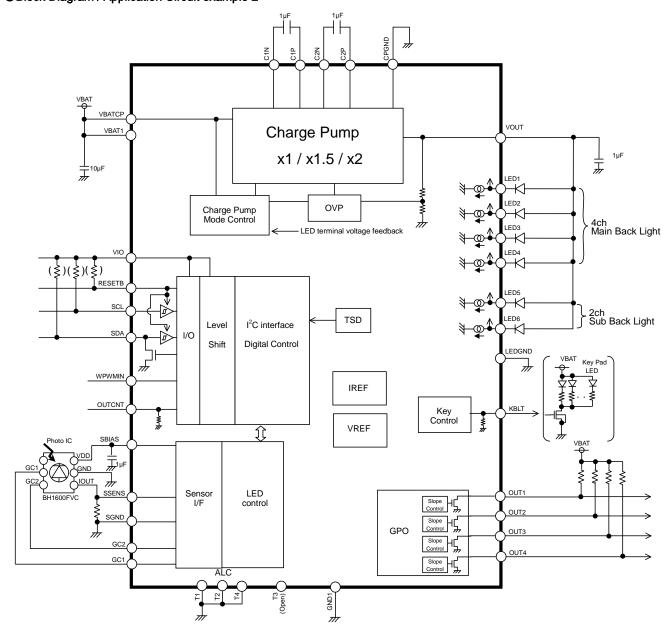


Fig.2 Block Diagram / Application Circuit example 2

●Pin Arrangement [Bottom View]

F		T4	SSENS	SGND	VBAT1	VIO	Т3	
E		SBIAS	GC1	GC2	SDA	OUT2	OUT4	
D		LED5	LED6	SCL	OUT1	OUT3	VOUT	
С		LEDGND	LED4	OUTCNT	WPWMIN	C1P	C2P	
В		LED2	LED3	RESETB	KBLT	C2N	VBATCP	
Α	INDEX	T1	LED1	GND1	C1N	CPGND	T2	
	0						<u>. </u>	
Į.	-	1	2	3	4	5	6	

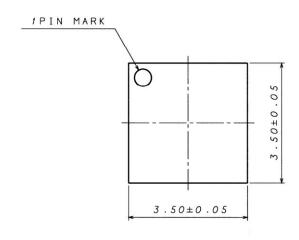
6 x 6 Ball

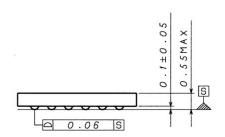
●Package

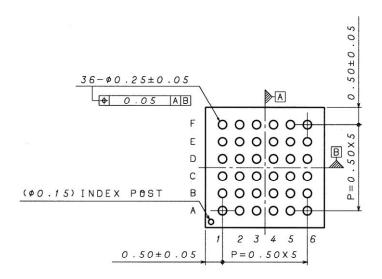
VCSP50L3 CSP small package

SIZE: 3.50mm×3.50mm(A difference in public: X,Y Both ±0.05mm) Height: 0.55mm max

A ball pitch: 0.5 mm²







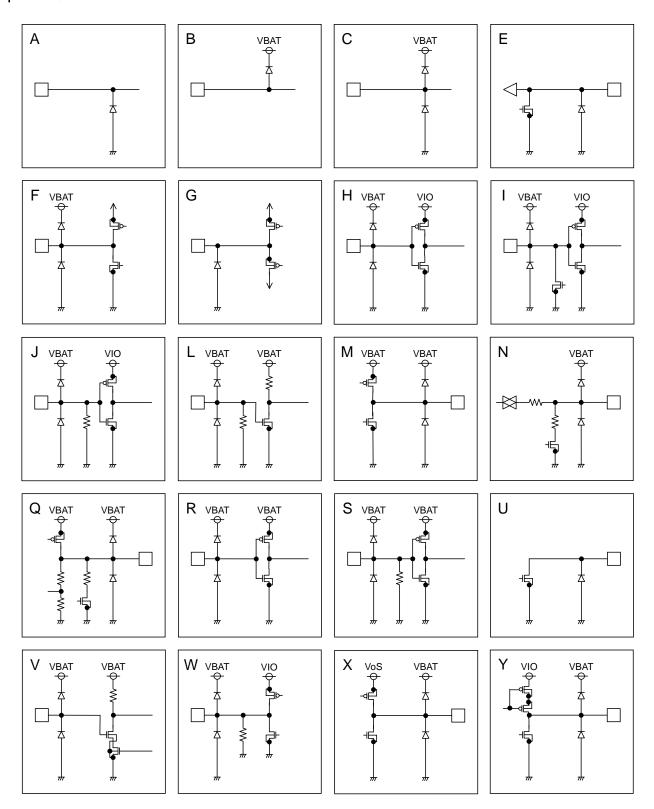
(UNIT:mm)

●Pin Functions

				ESD	Diode		Equivalent
No	Ball No.	Pin Name	I/O	For Power	For Ground	Functions	Circuit
1	В6	VBATCP	-	-	GND	Battery is connected	Α
2	F4	VBAT1	-	-	GND	Battery is connected	А
3	A1	T1	I	VBAT	-	Test Ground Pin(short to Ground)	В
4	A6	T2	I	VBAT	GND	Test Input Pin (short to Ground)	S
5	F6	T3	0	VBAT	GND	Test Output Pin(Open)	М
6	F1	T4	I	VBAT	GND	Test Input Pin (short to Ground)	S
7	F5	VIO	-	VBAT	GND	I/O Power supply is connected	С
8	В3	RESETB	I	VBAT	GND	Reset input (L: reset, H: reset cancel)	Н
9	E4	SDA	I/O	VBAT	GND	I ² C data input / output	I
10	D3	SCL	I	VBAT	GND	I ² C clock input	Н
11	A5	CPGND	-	VBAT	-	Ground	В
12	А3	GND1	-	VBAT	-	Ground	В
13	C1	LEDGND	-	VBAT	-	Ground	В
14	A4	C1N	I/O	VBAT	GND	Charge Pump capacitor is connected	F
15	C5	C1P	I/O	-	GND	Charge Pump capacitor is connected	G
16	B5	C2N	I/O	VBAT	GND	Charge Pump capacitor is connected	F
17	C6	C2P	I/O	-	GND	Charge Pump capacitor is connected	G
18	D6	VOUT	0	-	GND	Charge Pump output pin	А
19	A2	LED1	I	-	GND	LED is connected 1 for LCD Back Light	Е
20	B1	LED2	I	-	GND	LED is connected 2 for LCD Back Light	Е
21	B2	LED3	I	-	GND	LED is connected 3 for LCD Back Light	Е
22	C2	LED4	I	-	GND	LED is connected 4 for LCD Back Light	Е
23	D1	LED5	I	-	GND	LED is connected 5 for LCD Back Light	Е
24	D2	LED6	I	-	GND	LED is connected 6 for LCD Back Light	Е
25	E1	SBIAS	0	VBAT	GND	Bias output for the Ambient Light Sensor	Q
26	F2	SSENS	I	VBAT	GND	Ambient Light Sensor input	N
27	E2	GC1	0	VBAT	GND	Ambient Light Sensor gain control output 1	X
28	E3	GC2	0	VBAT	GND	Ambient Light Sensor gain control output 2	X
29	F3	SGND	-	VBAT	-	Ground	В
30	D4	OUT1	0	-	GND	General Output Port 1	U
31	E5	OUT2	0	-	GND	General Output Port 1	U
32	D5	OUT3	0	-	GND	General Output Port 1	U
33	E6	OUT4	0	-	GND	General Output Port 1	U
34	C4	WPWMIN	I	VBAT	GND	External PWM input for Back Light *	V
35	C3	OUTCNT	I	VBAT	GND	OUT1,2,3,4 Output Control (L:OFF) *	L
36	B4	KBLT	0	VBAT	GND	Key Back Light Control Output	W

^{*} A setup of a register is separately necessary to make it effective.

●Equivalent Circuit



●I²C BUS format

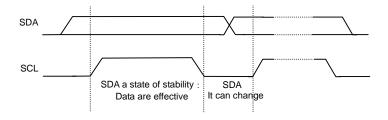
The writing/reading operation is based on the I²C slave standard.

· Slave address

A7	A6	A5	A4	А3	A2	A1	R/W
1	1	1	0	1	1	0	1/0

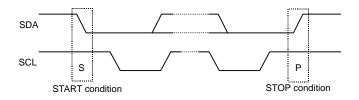
Bit Transfer

SCL transfers 1-bit data during H. SCL cannot change signal of SDA during H at the time of bit transfer. If SDA changes while SCL is H, START conditions or STOP conditions will occur and it will be interpreted as a control signal.



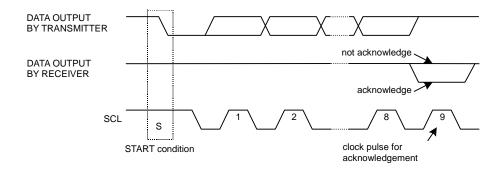
· START and STOP condition

When SDA and SCL are H, data is not transferred on the I²C- bus. This condition indicates, if SDA changes from H to L while SCL has been H, it will become START (S) conditions, and an access start, if SDA changes from L to H while SCL has been H, it will become STOP (P) conditions and an access end.



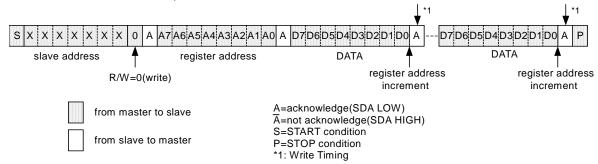
Acknowledge

It transfers data 8 bits each after the occurrence of START condition. A transmitter opens SDA after transfer 8bits data, and a receiver returns the acknowledge signal by setting SDA to L.



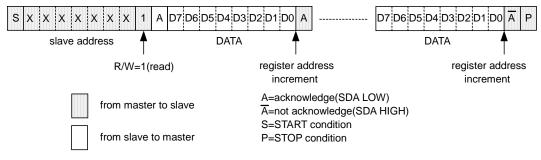
· Writing protocol

A register address is transferred by the next 1 byte that transferred the slave address and the write-in command. The 3rd byte writes data in the internal register written in by the 2nd byte, and after 4th byte or, the increment of register address is carried out automatically. However, when a register address turns into the last address, it is set to 00h by the next transmission. After the transmission end, the increment of the address is carried out.



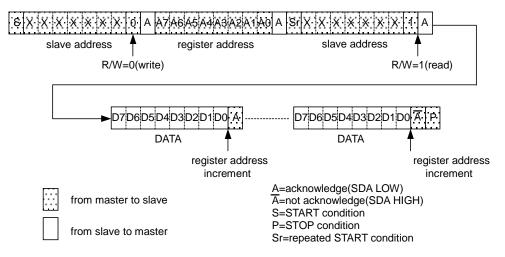
· Reading protocol

It reads from the next byte after writing a slave address and R/W bit. The register to read considers as the following address accessed at the end, and the data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



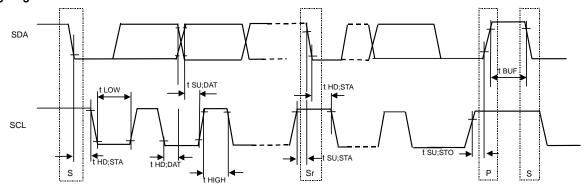
· Multiple reading protocols

After specifying an internal address, it reads by repeated START condition and changing the data transfer direction. The data of the address that carried out the increment is read after it. If an address turns into the last address, the next byte will read out 00h. After the transmission end, the increment of the address is carried out.



As for reading protocol and multiple reading protocols, please do \overline{A} (not acknowledge) after doing the final reading operation. It stops with read when ending by A(acknowledge), and SDA stops in the state of Low when the readingdata of that time is 0. However, this state returns usually when SCL is moved, data is read, and A(not acknowledge)is done.

●Timing diagram



● Electrical Characteristics(Unless otherwise specified, Ta=25 °C, VBAT=3.6V, VIO=2.6V)

Description	0	Sta	andard-m	ode	F	ast-mode		1.124
Parameter	Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
[I ² C BUS format]								
SCL clock frequency	fscl	0	-	100	0	-	400	kHz
LOW period of the SCL clock	tLOW	4.7	-	-	1.3	-	-	μs
HIGH period of the SCL clock	tHIGH	4.0	-	-	0.6	-	-	μs
Hold time (repeated) START condition After this period, the first clock is generated	tHD;STA	4.0	-	-	0.6	-	-	μs
Set-up time for a repeated START condition	tsu;sta	4.7	-	-	0.6	-	-	μs
Data hold time	thd;dat	0	-	3.45	0	-	0.9	μs
Data set-up time	tsu;dat	250	-	-	100	-	-	ns
Set-up time for STOP condition	tsu;sto	4.0	-	-	0.6	-	-	μs
Bus free time between a STOP and START condition	tBUF	4.7	-	-	1.3	-	-	μs

●Register List

Address	W/R				Regist	er data				Function
Address	W/K	D7	D6	D5	D4	D3	D2	D1	D0	Function
00h	W	VOUT(1)	VOUT(0)	DCDCMD	DCDCFON	-	-	-	SFTRST	Software Reset DC/DC function setting
01h	W	WPWMEN	WPWMPOL	-	-	W6MD	W5MD	W4MD	MLEDMD	LED Pin function setting
02h	W/R	-	-	-	-	ALCEN	W6EN	W5EN	MLEDEN	Power Control
03h	W	-	IMLED(6)	IMLED(5)	IMLED(4)	IMLED(3)	IMLED(2)	IMLED(1)	IMLED(0)	Main group current setting
04h	W	-	IW5(6)	IW5(5)	IW5(4)	IW5(3)	IW5(2)	IW5(1)	IW5(0)	LED5 current setting
05h	W	-	IW6(6)	IW6(5)	IW6(4)	IW6(3)	IW6(2)	IW6(1)	IW6(0)	LED6 current setting
06h	W	THL (3)	THL (2)	THL (1)	THL (0)	TLH (3)	TLH (2)	TLH (1)	TLH (0)	Main Current transition
07h	W	ADCYC (1)	ADCYC (0)	GAIN (1)	GAIN(0)	STYPE	VSB	MDCIR	SBIASON	Measurement mode setting
08h	W	SOFS (3)	SOFS (2)	SOFS (1)	SOFS (0)	SGAIN (3)	SGAIN (2)	SGAIN (1)	SGAIN (0)	Measurement data adjustment
09h	R	-	-	-	-	AMB (3)	AMB (2)	AMB (1)	AMB (0)	Ambient level
0Ah	W	-	IU0 (6)	IU0 (5)	IU0 (4)	IU0 (3)	IU0 (2)	IU0 (1)	IU0 (0)	LED Current at Ambient level 0h
0Bh	W	-	IU1 (6)	IU1 (5)	IU1 (4)	IU1 (3)	IU1 (2)	IU1 (1)	IU1 (0)	LED Current at Ambient level 1h
0Ch	W	-	IU2 (6)	IU2 (5)	IU2 (4)	IU2 (3)	IU2 (2)	IU2 (1)	IU2 (0)	LED Current at Ambient level 2h
0Dh	W	-	IU3 (6)	IU3 (5)	IU3 (4)	IU3 (3)	IU3 (2)	IU3 (1)	IU3 (0)	LED Current at Ambient level 3h
0Eh	W	-	IU4 (6)	IU4 (5)	IU4 (4)	IU4 (3)	IU4 (2)	IU4 (1)	IU4 (0)	LED Current at Ambient level 4h
0Fh	W	-	IU5 (6)	IU5 (5)	IU5 (4)	IU5 (3)	IU5 (2)	IU5 (1)	IU5 (0)	LED Current at Ambient level 5h
10h	W	-	IU6 (6)	IU6 (5)	IU6 (4)	IU6 (3)	IU6 (2)	IU6 (1)	IU6 (0)	LED Current at Ambient level 6h
11h	W	-	IU7 (6)	IU7 (5)	IU7 (4)	IU7 (3)	IU7 (2)	IU7 (1)	IU7 (0)	LED Current at Ambient level 7h
12h	W	-	IU8 (6)	IU8 (5)	IU8 (4)	IU8 (3)	IU8 (2)	IU8 (1)	IU8 (0)	LED Current at Ambient level 8h
13h	W	-	IU9 (6)	IU9 (5)	IU9 (4)	IU9 (3)	IU9 (2)	IU9 (1)	IU9 (0)	LED Current at Ambient level 9h
14h	W	-	IUA (6)	IUA (5)	IUA (4)	IUA (3)	IUA (2)	IUA (1)	IUA (0)	LED Current at Ambient level Ah
15h	W	-	IUB (6)	IUB (5)	IUB (4)	IUB (3)	IUB (2)	IUB (1)	IUB (0)	LED Current at Ambient level Bh
16h	W	-	IUC (6)	IUC (5)	IUC (4)	IUC (3)	IUC (2)	IUC (1)	IUC (0)	LED Current at Ambient level Ch
17h	W	-	IUD (6)	IUD (5)	IUD (4)	IUD (3)	IUD (2)	IUD (1)	IUD (0)	LED Current at Ambient level Dh
18h	W	-	IUE (6)	IUE (5)	IUE (4)	IUE (3)	IUE (2)	IUE (1)	IUE (0)	LED Current at Ambient level Eh
19h	W	-	IUF (6)	IUF (5)	IUF (4)	IUF (3)	IUF (2)	IUF (1)	IUF (0)	LED Current at Ambient level Fh
1Ah	W	-	-	CHYS (1)	CHYS (0)	CTH (3)	CTH (2)	CTH (1)	CTH (0)	Key driver 2 Value judging control setup
1Bh	W	-	-	-	KBMD	OUT4MD	OUT3MD	OUT2MD	OUT1MD	OUT, KBLT Output Mode setting
1Ch	W/R	-	-	-	KBEN	OUT4EN	OUT3EN	OUT2EN	OUT1EN	OUT, KBLT Output Control
1Dh	W	FPWM	-	-	-	KBSLP(1)	KBSLP(0)	OUTSLP(1)	OUTSLP(0)	OUT, KBLT Slope setting

Input "0" for "-".

A free address has the possibility to assign it to the register for the test. Access to the register for the test and the undefined register is prohibited.

●Register Map

Address 00h < Software Reset , DC/DC function setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
00h	W	VOUT(1)	VOUT(0)	DCDCMD	DCDCFON	-	-	-	SFTRST
Initial Value	00h	0	0	0	0	-	-	-	0

Bit [7:6]: VOUT (1:0) VOUT Output Voltage setting

"00": VOUT Output Voltage 3.9V"01": VOUT Output Voltage 4.2V"10": VOUT Output Voltage 4.5V"11": VOUT Output Voltage 4.8V

Bit [5:4]: DCDCMD, DCDCFON DC/DC setting

<DC/DC Return Mode>

LED Pin Return

Depend on LED ON/OFF

LEDPin Return

Depend on LED ON/OFF

Depend on LED ON/OFF

"10": Output Voltage Fixation Depend on LED ON/OFF

"11": Output Voltage Fixation Compulsion ON

Bit [3:1]: (Not used)

"00":

"01":

Bit0: SFTRST Software Reset

"0": Reset cancel

"1": Reset(All register initializing)

Refer to "The explanation of Reset" for detail.

Address 01h < LED Pin function setting>

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
01h	W	WPWMEN	WPWMPOL	-	-	W6MD	W5MD	W4MD	MLEDMD
Initial Value	42h	0	1	-	-	0	0	1	0

Bit7: WPWMEN External PWM Input "WPWMIN" terminal Enable Control (Valid/Invalid)

"0": External PWM input invalid "1": External PWM input valid

Refer to "(11) Current Adjustment" of "The explanation of ALC" for detail.

Bit6: WPWMPOL Polarity setting of External PWM input "WPWMIN" terminal

"0": External PWM 'L' drive "1": External PWM 'H' drive

Refer to "(11) Current Adjustment" of "The explanation of ALC" for detail.

Bit [5:4]: (Not used)

Bit3: W6MD LED6 control setting (individual / Main group)

"0": LED6 individual control
"1": LED6 Main group control
Refer to "LED Driver" for detail.

Bit2: W5MD LED5 control setting (individual / Main group)

"0": LED5 individual control
"1": LED5 Use (Main group)
Refer to "LED Driver" for detail.

Bit1: W4MD LED4 movement setting (unuse / use)

"0": LED4 unuse

"1": LED4 use (Main group Control)

Refer to "LED Driver" for detail.

Bit0: MLEDMD Main group setting (Normal / ALC)

"0": Main group Normal Mode(ALCNon-reflection)

"1": Main group ALC Mode

Refer to "(1) Auto Luminous Control ON/OFF" of "The explanation of ALC" for detail.

Set up a fixation in every design because it isn't presumed W*PW that it is changed dynamically. And, do the setup of W*PW when each LED is Off.

Address 02h < Power Control>

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
02h	W/R	-	-	-	-	ALCEN	W6EN	W5EN	MLEDEN
Initial Value	00h	-	-	-	-	0	0	0	0

Bit [7:4]: (Not used)

Bit3: ALCEN ALC function Control (ON/OFF)

"0": ALC block OFF

"1": ALC block ON (Ambient Measurement)

Bit2: W6EN LED6 Control (ON/OFF)

"0": LED6 OFF

"1": LED6 ON(individual control)

Bit1: W5EN LED5 Control (ON/OFF)

"0": LED5 OFF

"1": LED5 ON(individual control)

Bit0: MLEDEN Main group LED Control (ON/OFF)

"0": Main group OFF
"1": Main group ON

Address 03h < Main group LED Current setting(Normal Mode) >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
03h	W	-	IMLED(6)	IMLED(5)	IMLED(4)	IMLED(3)	IMLED(2)	IMLED(1)	IMLED(0)
Initial Value	00h	=	0	0	0	0	0	0	0

Bit [6:0]: IMLED (6:0) Main Group LED Current Setting at non-ALC mode

ivialii	•	Current Setting at the	III-ALC IIIO
"0000000" :		"1000000":	13.0 mA
"0000001" :	0.4 mA	"1000001":	13.2 mA
"0000010":	0.6 mA	"1000010":	13.4 mA
"0000011" :	0.8 mA	"1000010":	13.6 mA
		"1000100":	
"0000100" :	1.0 mA		13.8 mA
"0000101":	1.2 mA	"1000101" :	14.0 mA
"0000110":	1.4 mA	"1000110" :	14.2 mA
"0000111":	1.6 mA	"1000111" :	14.4 mA
"0001000" :	1.8 mA	"1001000":	14.6 mA
"0001000":	2.0 mA	"1001000":	14.8 mA
		1001001 .	
"0001010" :	2.2 mA	"1001010":	15.0 mA
"0001011":	2.4 mA	"1001011":	15.2 mA
"0001100" :	2.6 mA	"1001100" :	15.4 mA
"0001101":	2.8 mA	"1001101" :	15.6 mA
"0001110":	3.0 mA	"1001110" :	15.8 mA
"0001111" :	3.2 mA	"1001111" :	16.0 mA
		"1010000":	
"0010000" :	3.4 mA		16.2 mA
"0010001":	3.6 mA 3.8 mA	"1010001":	16.4 mA
"0010010":	3.8 mA	"1010010" :	16.6 mA
"0010011":	4.0 mA	"1010011" :	16.8 mA
"0010100":	4.2 mA	"1010100":	17.0 mA
"0010101" :	4.4 mA	"1010101" :	17.2 mA
"0010101":	4.6 mA	"1010110":	17.4 mA
		1010110 :	
"0010111":	4.8 mA	"1010111":	17.6 mA
"0011000" :	5.0 mA	"1011000" :	17.8 mA
"0011001" :	5.2 mA	"1011001" :	18.0 mA
"0011010":	5.4 mA	"1011010" :	18.2 mA
"0011011" :	5.6 mA	"1011011" :	18.4 mA
		"1011100" :	
"0011100":	5.8 mA		18.6 mA
"0011101":	6.0 mA	"1011101" :	18.8 mA
"0011110" :	6.2 mA	"1011110" :	19.0 mA
"0011111":	6.4 mA	"1011111" :	19.2 mA
"0100000" :	6.6 mA	"1100000" :	19.4 mA
"0100001":	6.8 mA	"1100001":	19.6 mA
"0100010" :	7.0 mA	"1100010" :	19.8 mA
"0100011":	7.2 mA	"1100011":	20.0 mA
"0100100":	7.4 mA	"1100100":	20.2 mA
"0100101" :	7.6 mA	"1100101" :	20.4 mA
"0100110" :	7.8 mA	"1100110" :	20.6 mA
"0100111":	8.0 mA	"1100111" :	20.8 mA
"0101000" :	8.2 mA	"1101000" :	21.0 mA
"01010001" :	8.4 mA	"1101000":	21.2 mA
"0101010" :	8.6 mA	"1101010":	21.4 mA
"0101011":	8.8 mA	"1101011":	21.6 mA
"0101100" :	9.0 mA	"1101100" :	21.8 mA
"0101101" :	9.2 mA	"1101101" :	22.0 mA
"0101110":	9.4 mA	"1101110" :	22.2 mA
"0101111":	9.6 mA	"1101111":	22.4 mA
"0110000":	9.8 mA	"1110000" :	22.6 mA
"0110001" :	10.0 mA	"1110001":	22.8 mA
"0110010":	10.2 mA	"1110010" :	23.0 mA
"0110011" :	10.4 mA	"1110011" :	23.2 mA
"0110100" :	10.6 mA	"1110100" :	23.4 mA
"0110101":	10.8 mA	"1110101" :	23.6 mA
"0110110" :	11.0 mA	"1110110" :	23.8 mA
"0110110 .	11.0 IIIA	"1110111":	
"0110111":	11.2 mA	1110111 :	24.0 mA
"0111000" :	11.4 mA	"1111000" :	24.2 mA
"0111001" :	11.6 mA	"1111001" :	24.4 mA
"0111010":	11.8 mA	"1111010" :	24.6 mA
"0111011":	12.0 mA	"1111011":	24.8 mA
"0111100" :	12.2 mA	"1111100":	25.0 mA
"0111100":	12.4 mA	"111100":	25.2 mA
		11111U1 . "4444440" :	
"0111110" :	12.6 mA	"111110":	25.4 mA
"0111111" :	12.8 mA	"1111111":	25.6 mA

Address 04h < LED5 Current setting(Independence control) >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
Address	IN/ VV	Dit	Dito	DIIO	DIL4	DIG	DILZ	DILI	DILU
04h	W	-	IW5(6)	IW5(5)	IW5(4)	IW5(3)	IW5(2)	IW5(1)	IW5(0)
Initial Value	00h	-	0	0	0	0	0	0	0

Bit [6:0]: IW5 (6:0) LED5 Current setting

)		irrent setting		
	"0000000":	0.2 mA	"1000000":	13.0 mA
	"0000001":	0.4 mA	"1000001":	13.2 mA
	"0000010":	0.6 mA	"1000010" :	13.4 mA
	"0000011":	0.8 mA	"1000011" :	13.6 mA
	"0000100":	1.0 mA	"1000100":	13.8 mA
	"0000101":	1.2 mA	"1000101":	14.0 mA
	"0000110":	1.4 mA	"1000110":	14.2 mA
	"0000111":	1.6 mA	"1000111":	14.4 mA
	"0001000":	1.8 mA	"1001000" :	14.6 mA
	"0001001":	2.0 mA	"1001001" :	14.8 mA
	"0001010":	2.2 mA	"1001010" :	15.0 mA
	"0001010":	2.4 mA	"1001011" :	15.2 mA
	"0001100":	2.6 mA	"1001100" :	15.4 mA
	"0001100":	2.8 mA	"1001100":	15.6 mA
	"0001101":	3.0 mA	"1001101":	15.8 mA
	"0001110":	3.2 mA	"1001110":	16.0 mA
	"0010000":	3.4 mA	"1010000" :	16.2 mA
	"0010000":	3.6 mA	"1010000":	16.4 mA
	"0010001":	3.8 mA	"1010001":	16.4 mA
	"0010010 .		"1010010":	
	"0010011":	4.0 mA		16.8 mA
	"0010100":	4.2 mA	"1010100":	17.0 mA
	"0010101":	4.4 mA	"1010101":	17.2 mA
	"0010110":	4.6 mA	"1010110":	17.4 mA
	"0010111":	4.8 mA	"1010111" :	17.6 mA
	"0011000":	5.0 mA	"1011000" :	17.8 mA
	"0011001":	5.2 mA	"1011001":	18.0 mA
	"0011010":	5.4 mA	"1011010" :	18.2 mA
	"0011011":	5.6 mA	"1011011" :	18.4 mA
	"0011100":	5.8 mA	"1011100":	18.6 mA
	"0011101":	6.0 mA	"1011101" :	18.8 mA
	"0011110":	6.2 mA	"1011110":	19.0 mA
	"0011111":	6.4 mA	"1011111":	19.2 mA
	"0100000" :	6.6 mA	"1100000":	19.4 mA
	"0100001":	6.8 mA	"1100001":	19.6 mA
	"0100010":	7.0 mA	"1100010":	19.8 mA
	"0100011":	7.2 mA	"1100011" :	20.0 mA
	"0100100":	7.4 mA	"1100100":	20.2 mA
	"0100101":	7.6 mA	"1100101":	20.4 mA
	"0100110":	7.8 mA	"1100110" :	20.6 mA
	"0100111":	8.0 mA	"1100111" :	20.8 mA
	"0101000":	8.2 mA	"1101000":	21.0 mA
	"0101001" :	8.4 mA	"1101001" :	21.2 mA
	"0101010":	8.6 mA	"1101010":	21.4 mA
	"0101011" :	8.8 mA	"1101011":	21.6 mA
	"0101100" :	9.0 mA	"1101100" :	21.8 mA
	"0101101" :	9.2 mA	"1101101" :	22.0 mA
	"0101110":	9.4 mA	"1101110":	22.2 mA
	"0101111" :	9.6 mA	"1101111":	22.4 mA
	"0110000":	9.8 mA	"1110000" :	22.6 mA
	"0110001" :	10.0 mA	"1110001":	22.8 mA
	"0110010" :	10.2 mA	"1110010" :	23.0 mA
	"0110011":	10.4 mA	"1110011":	23.2 mA
	"0110100":	10.6 mA	"1110100":	23.4 mA
	"0110101" :	10.8 mA	"1110101" :	23.6 mA
	"0110110":	11.0 mA	"1110110" :	23.8 mA
	"0110111" :	11.2 mA	"1110111":	24.0 mA
	"0111000":	11.4 mA	"1111000" :	24.2 mA
	"0111001":	11.6 mA	"1111001" :	24.4 mA
	"0111010":	11.8 mA	"1111010":	24.6 mA
	"0111011":	12.0 mA	"1111011":	24.8 mA
	"0111100":	12.2 mA	"1111100" :	25.0 mA
	"0111101":	12.4 mA	"1111101":	25.2 mA
	"0111110":	12.6 mA	"1111110":	25.4 mA
	"0111111":	12.8 mA	"1111111":	25.6 mA

Address 05h < LED6 Current setting(Independence control) >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
05h	W	-	IW6(6)	IW6(5)	IW6(4)	IW6(3)	IW6(2)	IW6(1)	IW6(0)
Initial Value	00h	=	0	0	0	0	0	0	0

Bit [6:0]: IW6 (6:0) LED6 Current setting

)		ırrent setting		
	"0000000":	0.2 mA	"1000000":	13.0 mA
	"0000001":	0.4 mA	"1000001":	13.2 mA
	"0000010":	0.6 mA	"1000010" :	13.4 mA
	"0000011":	0.8 mA	"1000011" :	13.6 mA
	"0000100":	1.0 mA	"1000100":	13.8 mA
	"0000101":	1.2 mA	"1000101":	14.0 mA
	"0000110":	1.4 mA	"1000110":	14.2 mA
	"0000111":	1.6 mA	"1000111":	14.4 mA
	"0001000":	1.8 mA	"1001000" :	14.6 mA
	"0001001":	2.0 mA	"1001001" :	14.8 mA
	"0001010":	2.2 mA	"1001010" :	15.0 mA
	"0001010":	2.4 mA	"1001011" :	15.2 mA
	"0001100":	2.6 mA	"1001100" :	15.4 mA
	"0001100":	2.8 mA	"1001100":	15.6 mA
	"0001101":	3.0 mA	"1001101":	15.8 mA
	"0001110":	3.2 mA	"1001110":	16.0 mA
	"0010000":	3.4 mA	"1010000" :	16.2 mA
	"0010000":	3.6 mA	"1010000":	16.4 mA
	"0010001":	3.8 mA	"1010001":	16.4 mA
	"0010010 .		"1010010":	
	"0010011":	4.0 mA		16.8 mA
	"0010100":	4.2 mA	"1010100":	17.0 mA
	"0010101":	4.4 mA	"1010101":	17.2 mA
	"0010110":	4.6 mA	"1010110":	17.4 mA
	"0010111":	4.8 mA	"1010111" :	17.6 mA
	"0011000":	5.0 mA	"1011000":	17.8 mA
	"0011001":	5.2 mA	"1011001":	18.0 mA
	"0011010":	5.4 mA	"1011010":	18.2 mA
	"0011011":	5.6 mA	"1011011":	18.4 mA
	"0011100":	5.8 mA	"1011100":	18.6 mA
	"0011101":	6.0 mA	"1011101" :	18.8 mA
	"0011110" :	6.2 mA	"1011110":	19.0 mA
	"0011111":	6.4 mA	"1011111":	19.2 mA
	"0100000" :	6.6 mA	"1100000":	19.4 mA
	"0100001" :	6.8 mA	"1100001":	19.6 mA
	"0100010":	7.0 mA	"1100010":	19.8 mA
	"0100011":	7.2 mA	"1100011" :	20.0 mA
	"0100100":	7.4 mA	"1100100" :	20.2 mA
	"0100101" :	7.6 mA	"1100101":	20.4 mA
	"0100110" :	7.8 mA	"1100110" :	20.6 mA
	"0100111":	8.0 mA	"1100111":	20.8 mA
	"0101000":	8.2 mA	"1101000" :	21.0 mA
	"0101001":	8.4 mA	"1101001" :	21.2 mA
	"0101010":	8.6 mA	"1101010":	21.4 mA
	"0101011":	8.8 mA	"1101011":	21.6 mA
	"0101100":	9.0 mA	"1101100" :	21.8 mA
	"0101101":	9.2 mA	"1101101" :	22.0 mA
	"0101110":	9.4 mA	"1101110" :	22.2 mA
	"0101111":	9.6 mA	"1101111":	22.4 mA
	"0110000":	9.8 mA	"1110000":	22.6 mA
	"0110001" :	10.0 mA	"1110001" :	22.8 mA
	"0110010" :	10.2 mA	"1110010" :	23.0 mA
	"0110011":	10.4 mA	"1110010":	23.2 mA
	"0110100":	10.6 mA	"1110100" :	23.4 mA
	"0110101":	10.8 mA	"1110101":	23.6 mA
	"0110110" :	11.0 mA	"1110110" :	23.8 mA
	"0110110":	11.2 mA	"1110111":	24.0 mA
	"0111000" :	11.4 mA	"1111000" :	24.0 mA
	"0111000":	11.6 mA	"1111000":	24.4 mA
	"0111010":	11.8 mA	"1111011":	24.4 mA
	"0111010 .	12.0 mA	"1111010":	24.8 mA
	"0111011 .	12.0 MA 12.2 mA	"1111011 .	25.0 mA
	"0111100":	12.2 IIIA 12.4 mA	"1111100 . "1111101" :	25.0 mA
	"0111101 . "0111110" :	12.4 IIIA 12.6 mA	"1111101":	25.2 IIIA 25.4 mA
	"0111110":	12.8 mA	"1111110":	25.4 IIIA 25.6 mA
	OTITITI .	14.0 IIIA	11111111 .	23.0 IIIA

Address 06h < Main Current slope time setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
06h	W	THL(3)	THL(2)	THL(1)	THL(0)	TLH(3)	TLH(2)	TLH(1)	TLH(0)
Initial Value	C7h	1	1	0	0	0	1	1	1

Bit [7:4]: THL (3:0) Main LED current Down transition per 0.2mA step

"0000": 0.256 ms "0001": 0.512 ms "0010": 1.024 ms "0011": 2.048 ms 4.096 ms "0100": "0101": 8.192 ms "0110": 16.38 ms "0111": 32.77 ms "1000": 65.54 ms "1001": 131.1 ms "1010": 196.6 ms "1011": 262.1 ms

"1100": 327.7 ms (Initial value)

"1101": 393.2 ms "1110": 458.8 ms "1111": 524.3 ms

Setting time is counted based on the switching frequency of Charge Pump.

The above value becomes the value of the Typ (1MHz) time.

Refer to "(9) Slope Process" of "The explanation of ALC" for detail.

Bit [3:0]: TLH (3:0) Main LED current Up transition per 0.2mA step

"0000": 0.256 ms
"0001": 0.512 ms
"0010": 1.024 ms
"0011": 2.048 ms
"0100": 4.096 ms
"0101": 8.192 ms
"0110": 16.38 ms

"0111": 32.77 ms (Initial value)

"1000": 65.54 ms "1001": 131.1 ms "1010": 196.6 ms "1011": 262.1 ms "1100": 327.7 ms "1101": 393.2 ms "1110": 458.8 ms "1111": 524.3 ms

Setting time is counted based on the switching frequency of Charge Pump.

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The above value becomes the value of the Typ (1MHz) time.

Refer to "(9) Slope Process" of "The explanation of ALC" for detail.

Address 07h < ALC mode setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
07h	W	ADCYC(1)	ADCYC(0)	GAIN(1)	GAIN(0)	STYPE	VSB	MDCIR	SBIASON
Initial Value	81h	1	0	0	0	0	0	0	1

Bit [7:6]: ADCYC(1:0) ADC Measurement Cycle

"00": 0.52 s "01": 1.05 s

"10": 1.57 s (Initial value)

"11": 2.10 s

Refer to "(4) A/D conversion" of "The explanation of ALC" for detail.

Bit [5:4]: GAIN(1:0) Sensor Gain Switching Function Control (This is effective only at STYPE="0".)

"00": Auto Change (Initial value)

"01": High "10": Low "11": Fixed

Refer to "(3) Gain control" of "The explanation of ALC" for detail.

Bit3: STYPE Ambient Light Sensor Type Select (Linear/Logarithm)

"0": For Linear sensor (Initial value)

"1": For Log sensor

Refer to "(7) Ambient level detection" of "The explanation of ALC" for detail.

Bit2: VSB SBIAS Output Voltage Control

"0": SBIAS output voltage 3.0V (Initial value)

"1": SBIAS output voltage 2.6V

Refer to "(2) I/V conversion" of "The explanation of ALC" for detail.

Bit1: MDCIR LED Current Reset Select by Mode Change

"0": LED current non-reset when mode change (Initial value)

"1": LED current reset when mode change

Refer to "(10) LED current reset when mode change" of "The explanation of ALC" for detail.

Bit0: SBIASON

"0": Measurement cycle synchronous

"1": Usually ON (at ALCEN=1) (Initial value)

Refer to "(4) A/D conversion" of "The explanation of ALC" for detail.

Address 08h < ADC Data adjustment >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
08h	W	SOFS(3)	SOFS(2)	SOFS(1)	SOFS(0)	SGAIN(3)	SGAIN(2)	SGAIN(1)	SGAIN(0)
Initial Value	00h	0	0	0	0	0	0	0	0

Bit [7:4]: SOFS (3:0) ADC Data Offset adjustment

"1000": -8 LSB "1001": -7 LSB "1010": -6 LSB "1011": -5 LSB "1100": -4 LSB "1101": -3 LSB "1110": -2 LSB "1111": -1 LSB

"0000": no adjustment

"0001": +1 LSB
"0010": +2 LSB
"0011": +3 LSB
"0100": +4 LSB
"0101": +5 LSB
"0110": +6 LSB
"0111": +7 LSB

Offset adjust is performed to ADC data.

Refer to "(5) ADC data Gain/offset adjustment" of "The explanation of ALC" for detail.

Bit [3:0]: SGAIN (3:0) ADC Data Inclination adjustment

"1000": reserved "1001": reserved "1010": -37.50% "1011": -31.25% "1100": -25.00% "1101": -18.75% "1110": -12.50% "1111": -6.25%

"0000": no adjustment

"0001": +6.25%
"0010": +12.50%
"0011": +18.75%
"0100": +25.00%
"0101": +31.25%
"0110": +37.50%
"0111": reserved

Gain adjust is performed to ADC data.

The data after adjustment are round off by 8-bit data.

Refer to "(5) ADC data Gain/offset adjustment" of "The explanation of ALC" for detail.

Address 09h < Ambient level (Read Only) >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
09h	R	=	-	-	-	AMB(3)	AMB(2)	AMB(1)	AMB(0)
Initial Value	(00h)	=	-	-	-	(0)	(0)	(0)	(0)

Bit [7:4]: (Not used)

Bit [3:0]: AMB (3:0) Ambient Level

"0000": 0h "0001": 1h "0010": 2h "0011": 3h "0100": 4h "0101": 5h "0110": 6h "0111": 7h "1000": 8h "1001": 9h "1010": Ah "1011": Bh "1100": Ch "1101": Dh "1110": Eh "1111": Fh

It begins to read Ambient data through I2C, and possible.

To the first AD measurement completion, it is AMB(3:0)=0000.

Refer to "(7) Ambient level detection" of "The explanation of ALC" for detail.

Address 0Ah~19h < Ambient LED Current setting >

F	Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0	Ah~19h	W	IU*(7)	IU*(6)	IU*(5)	IU*(4)	IU*(3)	IU*(2)	IU*(1)	IU*(0)
	Initial Value	-			Refer	to after pag	ge for initial	table.		

[&]quot;*" means 0~F.

Bit [6:0]: IU* (6:0) Main Current at Ambient Level for 0h~Fh

"0000000":	0.2 mA	"1000000":	13.0 mA
"0000001":	0.4 mA	"1000001":	13.2 mA
		1000001 .	
"0000010":	0.6 mA	"1000010":	13.4 mA
"0000011":	0.8 mA	"1000011" :	13.6 mA
"0000100":	1.0 mA	"1000100" :	13.8 mA
"0000101":	1.2 mA	"1000101" :	14.0 mA
"0000110":	1.4 mA	"1000110":	14.2 mA
"0000111":	1.6 mA	"1000111" :	14.4 mA
"0001000" :	1.8 mA	"1001000" :	14.6 mA
		1001000 .	
"0001001":	2.0 mA	"1001001":	14.8 mA
"0001010":	2.2 mA	"1001010":	15.0 mA
"0001011":	2.4 mA	"1001011" :	15.2 mA
"0001100":	2.6 mA	"1001100" :	15.4 mA
"0001101":	2.8 mA	"1001101" :	15.6 mA
"0001110":	3.0 mA	"1001110":	15.8 mA
"0001111":	3.2 mA	"1001111" :	16.0 mA
	3.4 mA	"1011111 .	16.2 mA
"0010000":		"1010000" :	
"0010001":	3.6 mA	"1010001":	16.4 mA
"0010010":	3.8 mA	"1010010" :	16.6 mA
"0010011" :	4.0 mA	"1010011" :	16.8 mA
"0010100":	4.2 mA	"1010100":	17.0 mA
"0010101":	4.4 mA	"1010101":	17.2 mA
"0010110":	4.6 mA	"1010110" :	17.4 mA
"0010110":	4.8 mA	"1010110":	17.6 mA
"0011000" :	5.0 mA	"1011000" :	17.8 mA
"0011001":	5.2 mA	"1011001" :	18.0 mA
"0011010":	5.4 mA	"1011010" :	18.2 mA
"0011011":	5.6 mA	"1011011" :	18.4 mA
"0011100":	5.8 mA	"1011100" :	18.6 mA
"0011101":	6.0 mA	"1011101" :	18.8 mA
"0011110":	6.2 mA	"1011110":	19.0 mA
"0011111":	6.4 mA	"1011111" :	19.2 mA
"0100000" :	6.6 mA	"1100000" :	19.4 mA
"0100000":		"1100001":	
	6.8 mA		19.6 mA
"0100010":	7.0 mA	"1100010" :	19.8 mA
"0100011":	7.2 mA	"1100011":	20.0 mA
"0100100":	7.4 mA	"1100100" :	20.2 mA
"0100101" :	7.6 mA	"1100101" :	20.4 mA
"0100110":	7.8 mA	"1100110" :	20.6 mA
"0100111":	8.0 mA	"1100111" :	20.8 mA
"0101000":	8.2 mA	"1101000" :	21.0 mA
"0101001" :	8.4 mA	"1101001" :	21.2 mA
"0101010":	8.6 mA	"1101010":	21.4 mA
		"1101010":	
"0101011":	8.8 mA		21.6 mA
"0101100" :	9.0 mA	"1101100" :	21.8 mA
"0101101":	9.2 mA	"1101101" :	22.0 mA
"0101110":	9.4 mA	"1101110" :	22.2 mA
"0101111":	9.6 mA	"1101111":	22.4 mA
"0110000":	9.8 mA	"1110000" :	22.6 mA
"0110001":	10.0 mA	"1110001" :	22.8 mA
"0110010":	10.2 mA	"1110010" :	23.0 mA
"0110010":	10.4 mA	"1110010":	23.2 mA
		"111010":	
"0110100" :	10.6 mA	1110100 .	23.4 mA
"0110101":	10.8 mA	"1110101":	23.6 mA
"0110110":	11.0 mA	"1110110":	23.8 mA
"0110111":	11.2 mA	"1110111":	24.0 mA
"0111000":	11.4 mA	"1111000" :	24.2 mA
"0111001" :	11.6 mA	"1111001" :	24.4 mA
"0111010":	11.8 mA	"1111010" :	24.6 mA
"0111011":	12.0 mA	"1111011":	24.8 mA
"0111100" :	12.2 mA	"111100":	25.0 mA
"0111101" :	12.4 mA	"1111101" :	25.2 mA
"011110":	12.5 mA	"111110":	25.4 mA
"0111111":	12.8 mA	"1111111":	25.4 mA
0111111 .	12.0 IIIA		20.0 IIIA

Address 1Ah < Key Driver 2 value decision control setting >

Addr	ess	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1A	'n	W	-	-	CHYS(1)	CHYS(0)	CTH(3)	CTH(2)	CTH(1)	CTH(0)
Initi Valu		2Ah	-	-	1	0	1	0	1	0

Bit [7:6]: (Not used)

Bit [5:4]: CHYS(1:0) Key DriverON Brightness hysteresis

"00": Ambient 1h Width"01": Ambient 2h Width"10": Ambient 3h Width (initial)"11": Ambient 4h Width

Refer to "(12) Key back light value decision" of "The explanation of ALC" for detail.

Bit [3:0]: CTH (3:0) Key DriverOFF Brightness threshold

"0000": Ambient level 0h OFF "0001": Ambient level 1h OFF "0010": Ambient level 2h OFF "0011": Ambient level 3h OFF "0100": Ambient level 4h OFF "0101": Ambient level 5h OFF "0110": Ambient level 6h OFF "0111": Ambient level 7h OFF "1000": Ambient level 8h OFF "1001": Ambient level 9h OFF Ambient level Ah OFF (initial) "1010":

"1011": Ambient level Bh OFF
"1100": Ambient level Ch OFF
"1101": Ambient level Dh OFF

"1110": Ambient level Eh OFF
"1111": Ambient level Fh OFF

Refer to "(12) Key back light value decision" of "The explanation of ALC" for detail.

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Address 1Bh < OUT KEY Output Mode setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1Bh	W	-	-	-	KBMD	OUT4MD	OUT3MD	OUT2MD	OUT1MD
Initial Value	00h	-	-	-	0	0	0	0	0

Bit [7:5]: (Not used)

Bit4: KBMD Key back light mode choice (ALC/ Individual)

> "0": KBLT ALC Control "1": KBLT Individual Control

Refer to "(13) Key back light PWM control" of "The explanation of "ALC" for detail.

Bit3: **OUT4MD** OUTCNT External Control setting

> "0": OUTCNT invalid, OUT4 output depends on output control by OUT4EN. "1": OUT4 output depends on output control by OUT4EN with OUTCNT=H. With OUTCNT=L, OUT4=Hi-z (compulsory off).

Refer to "The explanation of OUTPWM control" for detail.

Bit2: **OUT3MD** OUTCNT External Control setting

> "0": OUTCNT invalid, OUT3 output depends on output control by OUT3EN. "1":

OUT3 output depends on output control by OUT3EN with OUTCNT=H.

With OUTCNT=L, OUT3=Hi-z (compulsory off).

Refer to "The explanation of OUTPWM control" for detail.

Bit1: **OUT2MD** OUTCNT External Control setting

> "0": OUTCNT invalid, OUT2 output depends on output control by OUT2EN. "1": OUT2 output depends on output control by OUT2EN with OUTCNT=H.

> > With OUTCNT=L, OUT2=Hi-z (compulsory off).

Refer to "The explanation of OUTPWM control" for detail.

Bit0: **OUT1MD** OUTCNT External Control setting

> "0": OUTCNT invalid, OUT1 output depends on output control by OUT1EN.

> "1": OUT1 output depends on output control by OUT1EN with OUTCNT=H.

> > With OUTCNT=L, OUT1=Hi-z (compulsory off).

Refer to "The explanation of OUTPWM control" for detail.

Address 1Ch < OUT KEY Output level setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1Ch	W/R	-	-	-	KBEN	OUT4EN	OUT3EN	OUT2EN	OUT1EN
Initial Value	00h	-	-	-	0	0	0	0	0

Bit [7:5]: (Not used)

Bit4: KBEN KBLT output level setting (non-ALC mode)

"0": KBLT L 出力 "1": KBLT H 出力

Refer to "(13) Key back light PWM control" of "The explanation of ALC" for detail.

Bit3: OUT4EN OUT4 Output level setting

"0": OUT4 Hi-Z Output
"1": OUT4 L Output

Refer to "The explanation of OUTPWM control" for detail.

Bit2: OUT3EN OUT3 Output level setting

"0": OUT3 Hi-Z Output "1": OUT3 L Output

Refer to "The explanation of OUTPWM control" for detail.

Bit1: OUT2EN OUT2 Output level setting

"0": OUT2 Hi-Z Output
"1": OUT2 L Output

Refer to "The explanation of OUTPWM control" for detail..

Bit0: OUT1EN OUT1Output level setting

"0": OUT1 Hi-Z Output
"1": OUT1 L Output

Refer to "The explanation of OUTPWM control" for detail.

Address 1Dh < OUT KEY Output Mode setting >

Address	R/W	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
1Dh	W	FPWM	-	-	-	KBSLP (1)	KBSLP (0)	OUTSLP(1)	OUTSLP(0)
Initial Value	00h	0	-	-	-	0	0	0	0

Bit7: FPWM Key Driver, OUT1~4 PWM cycle setting

"0": 2.048 ms "1": 4.096 ms

Refer to "(13) Key back light PWM control" of "The explanation of ALC" and

"The explanation of OUTPWM control" for detail.

Bit [6:4]: (未使用)

Bit [3:2]: KBSLP(1:0) The slope time of around 1step for Key Driver PWM

FPWM=0 FPWM=1
"00": 0.00 ms 0.00 ms
"01": 16.38 ms 32.77 ms
"10": 32.77 ms 65.54 ms
"11": 65.54 ms 131.08 ms

Refer to "(13) Key back light PWM control" of "The explanation of ALC" for detail.

Bit [1:0]: OUTSLP(1:0) The slope time of around 1step for OUT1~4 PWM

FPWM=0 FPWM=1
"00": 0.00 ms 0.00 ms
"01": 16.38 ms 32.77 ms
"10": 32.77 ms 65.54 ms
"11": 65.54 ms 131.08 ms

Refer to "The explanation of OUTPWM control" for detail.

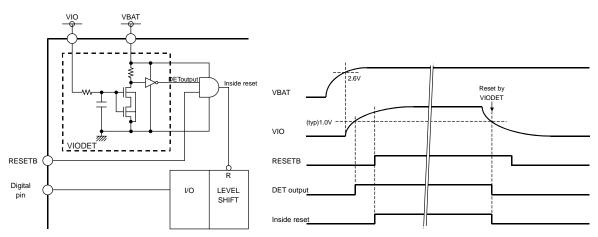
Reset

There are two kinds of reset, software reset and hardware reset

- (1) Software reset
 - All the registers are initialized by SFTRST="1".
 - · SFTRST is an automatically returned to "0". (Auto Return 0).
- (2) Hardware reset
 - It shifts to hardware reset by changing RESETB pin "H" → "L".
 - The condition of all the registers under hardware reset pin is returned to the initial value, and it stops accepting all address.
 - It's possible to release from a state of hardware reset by changing RESETB pin "L" → "H".
 - RESETB pin has delay circuit. It doesn't recognize as hardware reset in "L" period under 5µs.
- (3) Reset Sequence
 - When hardware reset was done during software reset, software reset is canceled when hardware reset is canceled. (Because the initial value of software reset is "0")

●VIODET

The decline of the VIO voltage is detected, and faulty operation inside the LSI is prevented by giving resetting to Levelsift block Image Block Diagram



When the VIO voltage becomes more than typ1.0V(Vth of NMOS in the IC), VIODET is removed. On the contrary, when VIO is as follows 1.0V, it takes reset.(The VBAT voltage being a prescribed movement range)

thermal shutdown

A thermal shutdown function is effective in the following block.

DC/DC (Charge Pump)

LED Driver

SBIAS

The thermal shutdown function is detection temperature that it works is about 195°C.

Detection temperature has a hysteresis, and detection release temperature is about 175 °C.

(Design reference value)

DC/DC Explanation for operate

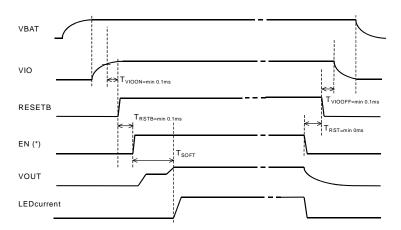
Start

DC/DC circuit operates when any LED turns ON. (DCDCFON=0)

When the start of the DC/DC circuit is done, it has the soft start function to prevent a rush current.

Force of VBAT and VIO is to go as follows.

DCDCMD=1 must be set in the fixed voltage mode and DCDCMD=DCDCFON=1 must be set when DCDC output takes place regardless of LEDs.



(*) An EN signal means the following in the upper figure.

EN = "MLEDEN" or "W * EN"

(= LED The LED lighting control of a setup of connection VOUT)

But, as for Ta > T_{TSD} (typ: 195° C), a protection function, and an EN signal doesn't become effective.

T_{SOFT} changes by the capacitor connected to VOUT and inside OSC.

 T_{SOFT} is Typ 200 μ s (when the output capacitor of VOUT =1.0 μ F).

Over Voltage protection / Over Current protection

DC/DC circuit output (VOUT) is equipped with the over-voltage protection and the over current protection function.

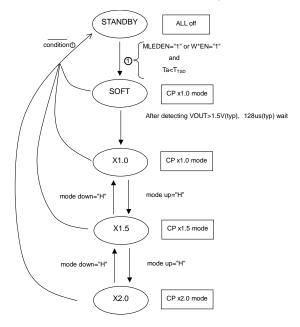
A VOUT over-voltage detection voltage is about 6.0V(typ). (VOUT at the time of rise in a voltage)

A detection voltage has a hysteresis, and a detection release voltage is about 5.1V(typ).

And, when VOUT output short to ground, input current of the battery terminal is limited by an over current protection function.

Mode transition

The transition of boosts multiple transits automatically by VBAT Voltage and the VOUT Pin Voltage.



The mode transition of the charge pump works as follows.

<x1.0→x1.5→x2.0 Mode transition>

The transition of the mode is done when VOUT was compared with VBAT and the next condition was satisfied.

x1.0→x1.5 Mode transition

VBAT ≤ VOUT + (Ron10×lout)

(LED Pin feedback : VOUT = Vf+0.2(Typ))

x1.5→x2.0 Mode transition

VBAT×1.5 ≤ VOUT +(Ron15×lout)

(LED Pin feedback : VOUT = Vf+0.2(Typ))

Ron10: x1 Charge pump on resistance 1.2 Ω (Typ) Ron15: x1.5 Charge pump on resistance 7.1 Ω (Typ)

$\langle x2.0 \rightarrow x1.5 \rightarrow x1.0 \text{ Mode transition} \rangle$

The transition of the mode is done when the ratio of VOUT and VBAT is detected and it exceeds a fixed voltage ratio.

x1.5→x1.0 Mode transition

VBAT / VOUT =1.16(Design value)

x2.0→x1.5 Mode transition

VBAT / VOUT =1.12(Design value)

●LED Driver

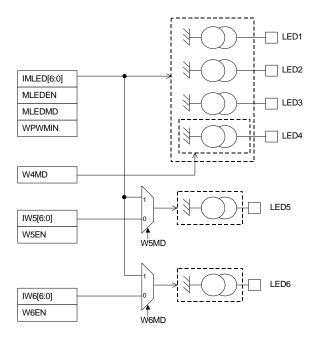
The LED driver of 6ch is constructed as the ground plan.

Equivalence control is possible with LED1 - 4(LED4 can choose use/un-use with a register W4MD.).

LED5, LED6 is controllable individually.

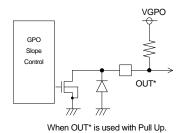
As for LED5, LED6, grouping setting to the main control is possible, and main control becomes effective for the main group in the allotment. LED5 and LED6 are setups of grouping to the main control.

When LED5 and LED6 are used by the individual control, a slope time setup (register THL and TLH) doesn't become effective.



General-purpose Output Ports

General-purpose Output Ports 4ch is constructed as the ground plan.



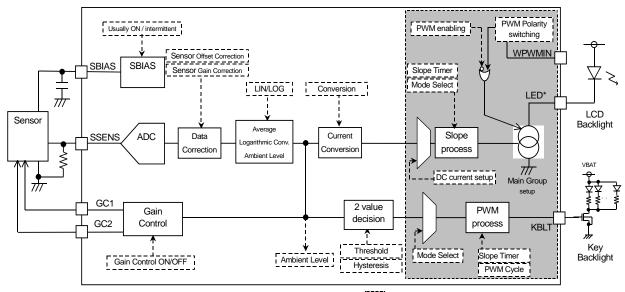
GPO Slope Control

When OUT* is used with LED.

●The explanation of ALC (Auto Luminous Control)

LCD backlight current adjustment is possible in the basis of the data detected by external ambient light sensor.

- Extensive selection of the ambient light sensors (Photo Diode, Photo Transistor, Photo IC(linear/logarithm)) is possible by building adjustment feature of Sensor bias, gain adjustment and offset adjustment.
- Ambient data is changed into ambient level by digital data processing, and it can be read through I²C I/F.
- Register setting can customize a conversion to LED current. (Initial value is pre-set.)
- · Natural dimming of LED driver is possible with the adjustment of the current transition speed.
- ON/ off of the key back light can be controlled automatically by the brightness.



: Effective also in ALC functional the case of not using it

(1) Auto Luminous Control ON/OFF

· ALC block can be independent setting ON/OFF.

It can use only to measure the Ambient level.

Register : ALCEN Register : MLEDEN Register : MLEDMD

· Refer to under about the associate ALC mode and Main LED current.

ALCEN	MLEDEN	MLEDMD	Sensor I/F	LED control	Mode	Main LED current	
0	0	Х	OFF	OFF	OFF	-	
0	1	0	(AMB(3:0)=0h)	ON	Non ALC	IMLED(6:0)	
0	1	1	(AND(3.0)=011)	ON	mode	IU0(6:0) (*1)	
1	0	х		OFF		-	
1	1	0	ON	ON	ALC mode	IMLED(6:0)	
1	1	1		ON		ALC mode (*2)	

^(*1) At this mode, because Sensor I/F is OFF, AMB(3:0)=0h.

So, Main LED current is selected IU0(6:0).

^(*2) At this mode, Main LED current is selected IU0(6:0)~IUF(6:0) It becomes current value corresponding to each brightness.

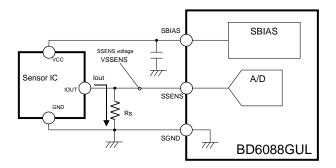
(2) I/V conversion

 The bias voltage and external resistance for the I-V conversion (Rs) are adjusted with adaptation of sensor characteristic

• The bias voltage is selectable by register setup.

Register: VSB

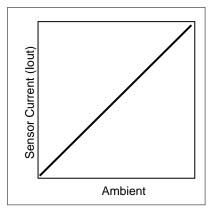
"0": SBIAS output voltage 3.0V "1": SBIAS output voltage 2.6V

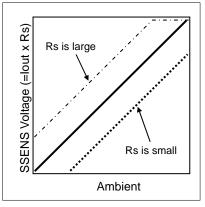


Rs: Sense resistance (A sensor output current is changed into the voltage value.) SBIAS: Bias power supply terminal for the sensor (3.0V / 2.6V by register setting)

SSENS : Sense voltage input terminal

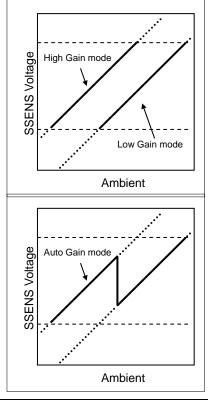
SSENS Voltage = lout x Rs





(3) Gain control

- Sensor gain switching function is built in to extend the dynamic range.
- It is controlled by register setup.
- When automatic gain control is off, the gain status can be set upin the manual. Register: GAIN(1:0)
- GC1 and GC2 are outputted corresponding to each gain status.



	Example 1 (Use BH1600FVC)					ŀ	Example 2		Example 3	
Applicationexample	SBIAS VCC IOUT SSENS BH1600 GC1 GC2 GC2 SGND				SSENS SSENS SSENS SCOT GC2 GC2 SCOND Resister values are relative			ENS 21 22 22 IND	SBIAS SSENS SSENS GC1 GC2 SGND	
Operating mode	Auto		Mar High	nual Low	Au	ito	Mar High	nual Low	Fixed	
GAIN(1:0) setting	0	00 01		10	0	0	01	10	11	
Gain status	High	Low	High	Low	High	Low	High	Low	-	
GC1 output	Л	L	Л	L	Л	L	Д	L	Л	
GC2 output	L	Л	L	Л	L	Л	L	Д	L	

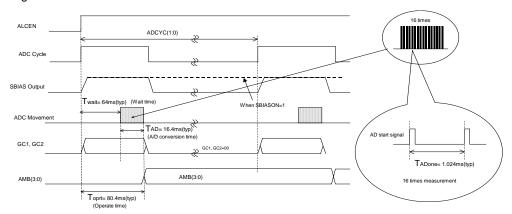
[:] This means that it becomes High with A/D measurement cycle synchronously.

^{(*1) :} Set up the relative ratio of the resistance in the difference in the brightness change of the High Gain mode and the Low Gain mode carefully.

(4) A/D conversion

- The detection of ambient data is done periodically for the low power.
- SBIAS and ADC are turned off except for the ambient measurement.
- The sensor current may be shut in this function, it can possible to decrease the current consumption.
- · SBIAS pin and SSENS pin are pull-down in internal when there are OFF.
- · SBIAS circuit has the two modes. (Usually ON mode or intermittent mode)

Register : ADCYC(1:0) Register : SBIASON



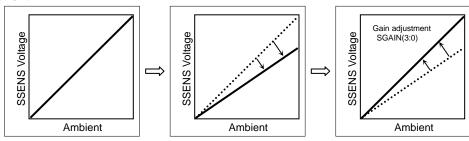
(5) ADC data Gain / offset adjustment

To correct the characteristic dispersion of the sensor,
 Gain and offset adjustment to ADC output data is possible.

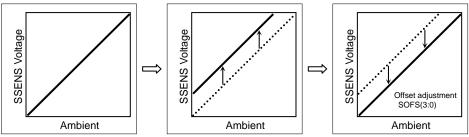
• They are controlled by register setup.

Register: SGAIN(3:0) Register: SOFS(3:0)

< Gain Adjustment >



< Offset Adjustment >



(6) Average filter

- · Average filter is built in to rid noise or flicker.
- Average is 16 times

(7) Ambient level detection

- · Averaged A/D value is converted to Ambient level corresponding to Gain control and sensor type.
- Ambient level is judged to rank of 16 steps by ambient data.
- The type of ambient light sensor can be chosen by register.

(Linear type sensor / Logarithm type sensor)

Register: STYPE
"0": For Linear sensor
"1": For Log sensor

• Ambient level is output through I²C.

Register: AMB(3:0)

STYPE	0					1
GAIN(1:0)	0	0	10	01	11	xx
GAIN	Low	High	Low	High	-	-
Ambient Level			SSENS	Voltage		
0h		VoS×0/256		VoS×0/256	VoS×0/256	VoS×0/256 VoS×17/256
1h		VoS×1/256		VoS×1/256	VoS×1/256	VoS×18/256 VoS×26/256
2h		VoS×2/256		VoS×2/256	VoS×2/256	VoS×27/256 VoS×36/256
3h		VoSx3/256 VoSx4/256		VoSx3/256 VoSx4/256	VoS×3/256 VoS×4/256	VoS×37/256 VoS×47/256
4h		VoS×5/256 VoS×7/256		VoS×5/256 VoS×7/256	VoS×5/256 VoS×6/256	VoS×48/256 VoS×59/256
5h	VoS×0/256	VoS×8/256 VoS×12/256	VoS×0/256	VoS×8/256 VoS×12/256	VoS×7/256 VoS×9/256	VoS×60/256 VoS×71/256
6h	VoS×1/256	VoS×13/256 VoS×21/256	VoS×1/256	VoS×13/256 VoS×21/256	VoS×10/256 VoS×13/256	VoS×72/256 VoS×83/256
7h	VoS×2/256 VoS×3/256	VoS×22/256 VoS×37/256	VoS×2/256 VoS×3/256	VoS×22/256 VoS×37/256	VoS×14/256 VoS×19/256	VoS×84/256 VoS×95/256
8h	VoS×4/256 VoS×6/256	VoS×38/256 VoS×65/256	VoS×4/256 VoS×6/256	VoS×38/256 VoS×65/256	VoS×20/256 VoS×27/256	VoS×96/256 VoS×107/256
9h	VoS×7/256 VoS×11/256	VoS×66/256 VoS×113/256	VoS×7/256 VoS×11/256	VoS×66/256 VoS×113/256	VoS×28/256 VoS×38/256	VoS×108/256 VoS×119/256
Ah	VoS×12/256 VoS×20/256	VoS×114/256 VoS×199/256	VoS×12/256 VoS×20/256	VoS×114/256 VoS×199/256	VoS×39/256 VoS×53/256	VoS×120/256 VoS×131/256
Bh	VoS×21/256 VoS×36/256	VoS×200/256 VoS×255/256	VoS×21/256 VoS×36/256	VoS×200/256 VoS×255/256	VoS×54/256 VoS×74/256	VoS×132/256 VoS×143/256
Ch	VoS×37/256 VoS×64/256		VoS×37/256 VoS×64/256	VOCALOGIZOS	VoS×75/256 VoS×104/256	VoS×144/256 VoS×155/256
Dh	VoS×65/256 VoS×114/256		VoS×65/256 VoS×114/256		VoS×105/256 VoS×144/256	VoS×156/256 VoS×168/256
Eh	VoS×115/256 VoS×199/256		VoS×115/256 VoS×199/256		VoS×145/256 VoS×199/256	VoS×169/256 VoS×181/256
Fh	VoSx199/236 VoSx200/256 VoSx255/256		VoSx199/236 VoSx200/256 VoSx255/256		VoS×200/256 VoS×255/256	VoSx181/236 VoSx182/256 VoSx255/256

[•] This is in case of not adjustments of the gain/offset control.

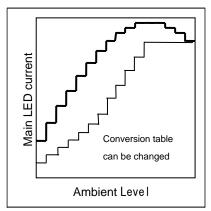
[•] In the Auto Gain control mode, sensor gain changes in gray-colored ambient level.

^{• &}quot;/": This means that this zone is not outputted in this mode.

(8) LED current assignment

- LED current can be assigned as each of 16 steps of the ambient level.
- Setting of a user can do by overwriting, though it prepares for the table setup in advance.

Register: IU*(6:0)



Conversion Table (initial value)

CONVENSION TABLE	(IIIIIai vaide)				
Ambient Level	Setting data	Current value	Ambient Level	Setting data	Current value
0h	11h	3.6mA	8h	48h	14.6mA
1h	13h	4.0mA	9h	56h	17.4mA
2h	15h	4.4mA	Ah	5Fh	19.2mA
3h	18h	5.0mA	Bh	63h	20.0mA
4h	1Eh	6.2mA	Ch	63h	20.0mA
5h	25h	7.6mA	Dh	63h	20.0mA
6h	2Fh	9.6mA	Eh	63h	20.0mA
7h	3Bh	12.0mA	Fh	63h	20.0mA

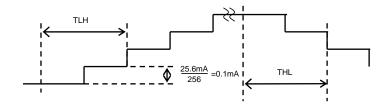
(9) Slope process

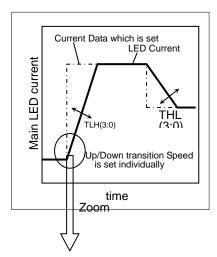
- Slope process is given to LED current to dim naturally.
- LED current changes in the 256Step gradation in sloping.
- Up(dark→bright),Down(bright→dark) LED current transition speed are set individually.

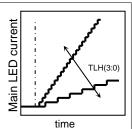
Register : THL(3:0) Register : TLH(3:0)

• Main LED current changes as follows at the time as the slope.

TLH (THL) is setup of time of the current step 2/256.







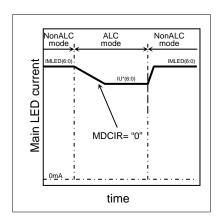
(10) LED current reset when mode change

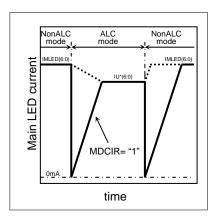
When mode is changed (ALC→Non ALC),

it can select the way to sloping.

Register: MDCIR

"0": LED current non-reset when mode change "1": LED current reset when mode change



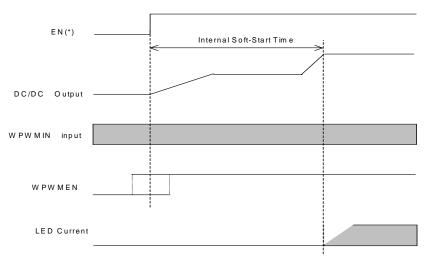


(11) Current adjustment

- When the register setting permits it, PWM drive by the external terminal (WPWMIN) is possible. B it Name : WPWMEN
- It is suitable for the intensity correction by external control, because PWM based on Main LED current of register setup or ALC control.

WPWMEN	WPWMIN(E	Main group	
(Register)	WPWMPOL=H (Register)	WPWMPOL=L (Register)	LED current
0	L	Н	Normal operation
0	Н	L	Normal operation
4	L	Н	Forced OFF
1	Н	L	Normal operation

[&]quot; Normal operation " depends on the setup of each register.



 $\mathsf{E}\,\mathsf{N}\,(^\star): \quad \mathsf{it}\,\mathsf{m}\,\mathsf{eans}\,\,^\star\!\mathsf{M}\,\mathsf{LE}\,\mathsf{D}\,\mathsf{E}\,\mathsf{N}\,^\sigma\,\mathsf{or}\,\,^\star\!\mathsf{W}\,\,^\star\!\mathsf{E}\,\mathsf{N}\,^\sigma.$

It is possible to make it a W PW MIN input and W PW MEN=1 in front of EN(*). A PW M drive becomes effective after the time of an LED current standup.

When rising during PWM operation, as for the standup time of a DC/DC output, only the rate of PWM Duty becomes late. Appearance may be influenced when extremely late frequency and extremely low Duty are inputted.

Please secure 80 μs or more of H sections at the time of PW M pulse Force.

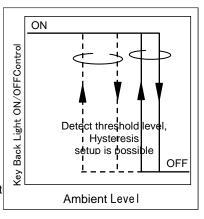
(12) Key back light 2-value decision

- Capable of comparing luminosity factor data with judgment threshold value with a hysteresis to determine binary judgment for illumination intensity.
- · Available for key backlight ON/OFF control based on illumination intensity.
- Sets a threshold value and a hystresis via the registers.

Bit Name: CTH(3:0) Bit Name: CHYS(1:0)

The threshold value and hystresis must meet the following condition: CTH setting ≥ CHYS setting

Example: The backlight turns on with an illumination intensity of 7 and turns off wit CTH[3:0]=7h CHYS[1:0]=1h



(13) Key back light PWM control

- · Outputs ON or OFF for binary judgment via the KBLT terminal after PWM processing.
- · Allows a slope time to be set in the register via PWM.

32 levels of duties prepared as MAX Duty are sequentially stepped at KBSLP time intervals.

Bit name: KBSLP(1:0)

· A PWM cycle can choose 2 value.

Bit name: FPWM

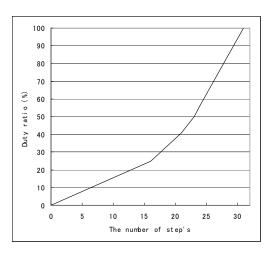
• It can be changed to the single control by the following setup of a register.

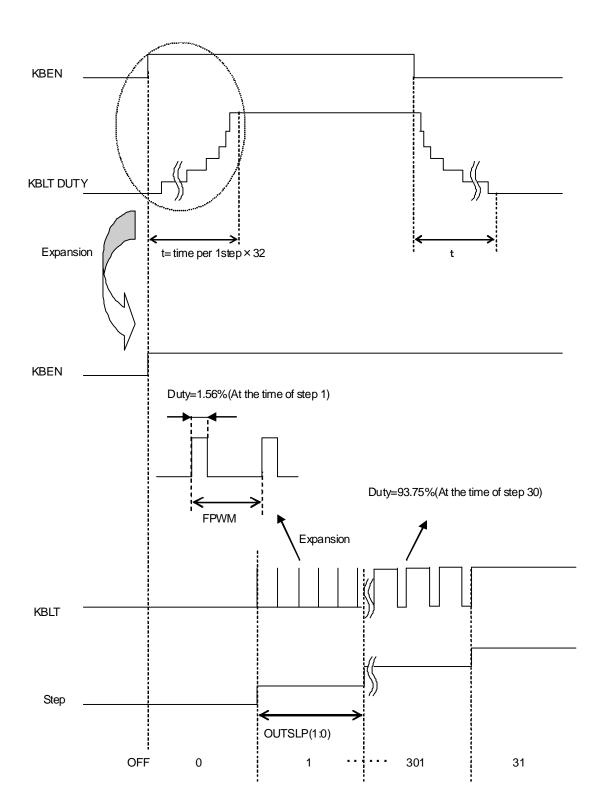
The KBSLP(1:0), FPWM setting is effective.

KBMD	KBEN	KBLT output
0	-	Depend on ALC setting
1	0	0
!	1	1

• 32 levels Duty ratio (H level section) becomes the following set point.

Step	Duty(%)	Step	Duty(%)
0	0.00	16	25.00
1	1.56	17	28.13
2	3.13	18	31.25
3	4.69	19	34.38
4	6.25	20	37.50
5	7.81	21	40.63
6	9.38	22	45.31
7	10.94	23	50.00
8	12.50	24	56.25
9	14.06	25	62.50
10	15.63	26	68.75
11	17.19	27	75.00
12	18.75	28	81.25
13	20.31	29	87.50
14	21.88	30	93.75
15	23.44	31	100.00





OUT PWM Control

• PWM A fixed signal is output from OUT1 ~ 4 terminal.

• Allows a slope time to be set in the register via PWM.

32 levels of duties prepared as MAX Duty are sequentially stepped at OUTSLP time intervals.

Bit name: OUTSLP(1:0)

- A PWM cycle can choose 2 value.

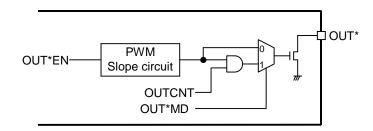
Bit name: FPWM

• Forced OFF is made with an OUTCNT terminal.

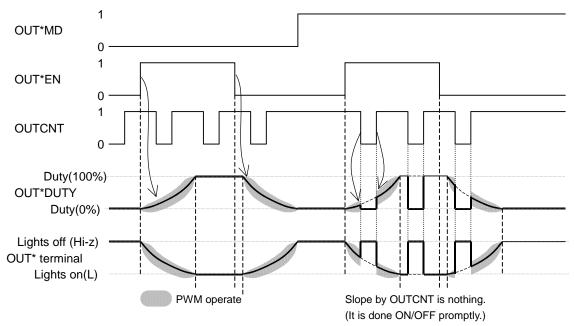
Bit name: OUT*MD

OUT*MD	OUT*EN	OUTCNT	OUT*出力	
0	-	After the PWM slope, Hi-z (Duty 0%)		
U	1	-	After the PWM slope, L (Duty 100%)	
	0	0	Hi-z (LED is compulsory lights off)	
1		1	Hi-z(Duty0%) *1	
'	1	0	Hi-z (LED is compulsory lights off	
		1	L (Duty100%) *	

^{*1} But, Duty in the middle of the PWM slope is output at the time as the PWM slope by OUT*EN.

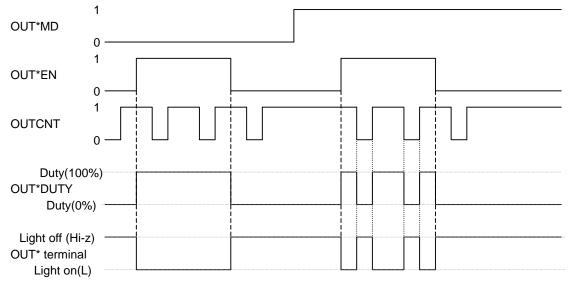


①Setup of a slope (Except for OUTSLP [1:0] =00h)



OUT*DUTY show the H section of the output step NMOS gate. (Duty 0%~100 %)

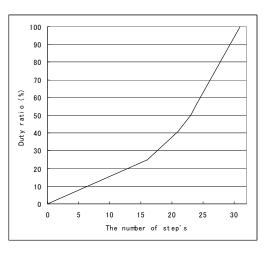
②Slope setup nothing (OUTSLP[1:0]=00h)

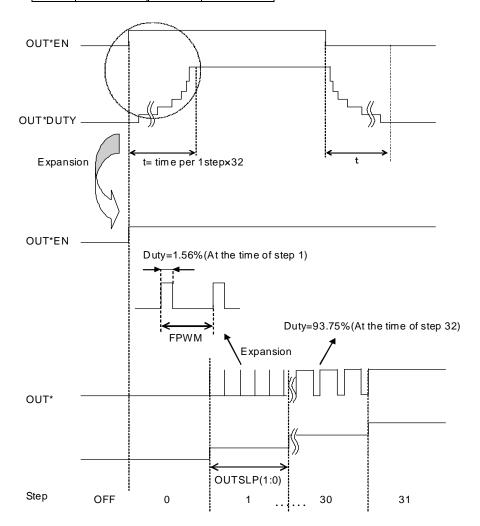


OUT*DUTY shows the H section of the output step NMOS gate. (Duty 0%~100%)

• 32 levels Duty ratio (H level section) becomes the following set point.

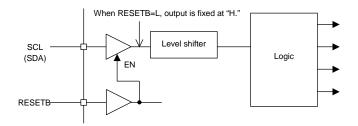
Step	Duty(%)	Step	Duty(%)
0	0.00	16	25.00
1	1.56	17	28.13
2	3.13	18	31.25
3	4.69	19	34.38
4	6.25	20	37.50
5	7.81	21	40.63
6	9.38	22	45.31
7	10.94	23	50.00
8	12.50	24	56.25
9	14.06	25	62.50
10	15.63	26	68.75
11	17.19	27	75.00
12	18.75	28	81.25
13	20.31	29	87.50
14	21.88	30	93.75
15	23.44	31	100.00





●I/O

When the RESETB pin is Low, the input buffers (SDA and SCL) are disabling for the Low consumption power.



Special care should be taken because a current path may be formed via a terminal protection diode, depending on an I/O power-on sequence or an input level.

■About the pin management of the function that isn't used and test pins

Setting it as follows is recommended with the test pin and the pin which isn't used.

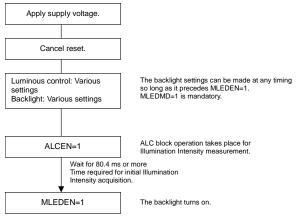
Set up pin referring to the "Equivalent circuit diagram" so that there may not be a problem under the actual use.

T1	Short to GND because pin for test GND		
T2, T4	Short to GND because pin for test input		
T3	OPEN because pin for test output		
Non-used LED Pin Short to GND (Must) But, the setup of a register concerned with LED that isn't used is prohibi			
WPWMIN, OUTCNT	Short to ground (A Pull-Down resistance built-in terminal is contained, too.)		
OUT1~4	It opens for an output		
KBLT	Although Pull-Down is built in, it opens for an output.		

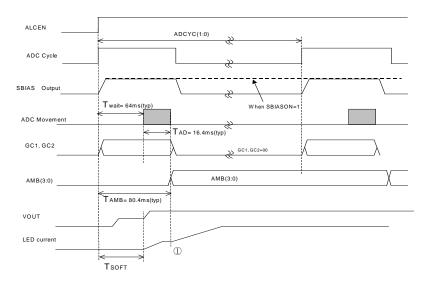
45/51

●Operation Settings (Flow Example)

1. Backlight: Auto luminous Mode

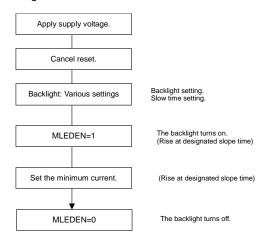


MLEDEN=0 must be set first when the backlight is off.

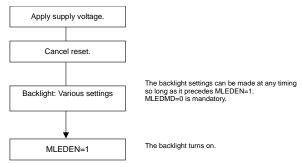


When It cannot wait for the first illumination measurement, backlight lighting is possible with ALCEN. But the extremely short case of slope rise time, a shoulder may be done like ① for an LED electric current. (To the first illumination measurement for AMB(3:0)=00h)

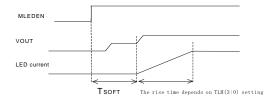
2. Backlight: Fade-in/Fade-out



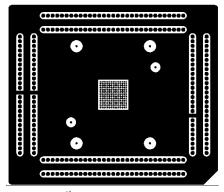
3. Backlight: Un-auto luminous Mode



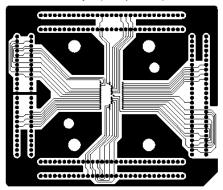
MLEDEN=0 must be set first when the backlight is off.



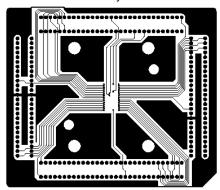
●PCB pattern of the Power dissipation measuring board



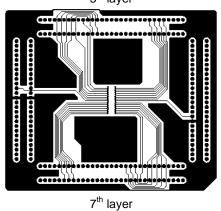
1st layer(component)

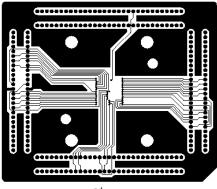


3rd layer

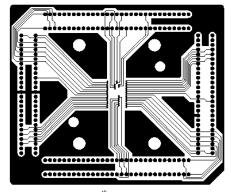


5th layer

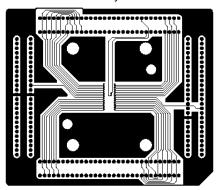




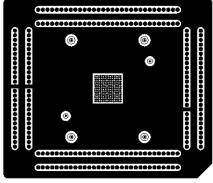
2nd layer



4th layer



6th layer



8th layer(solder)

Notes for use

(1) Absolute Maximum Ratings

An excess in the absolute maximum ratings, such as supply voltage, temperature range of operating conditions, etc., can break down devices, thus making impossible to identify breaking mode such as a short circuit or an open circuit. If any special mode exceeding the absolute maximum ratings is assumed, consideration should be given to take physical safety measures including the use of fuses, etc.

(2) Power supply and ground line

Design PCB pattern to provide low impedance for the wiring between the power supply and the ground lines. Pay attention to the interference by common impedance of layout pattern when there are plural power supplies and ground lines. Especially, when there are ground pattern for small signal and ground pattern for large current included the external circuits, please separate each ground pattern. Furthermore, for all power supply pins to ICs, mount a capacitor between the power supply and the ground pin. At the same time, in order to use a capacitor, thoroughly check to be sure the characteristics of the capacitor to be used present no problem including the occurrence of capacity dropout at a low temperature, thus determining the constant.

(3) Ground voltage

Make setting of the potential of the ground pin so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no pins are at a potential lower than the ground voltage including an actual electric transient.

(4) Short circuit between pins and erroneous mounting

In order to mount ICs on a set PCB, pay thorough attention to the direction and offset of the ICs. Erroneous mounting can break down the ICs. Furthermore, if a short circuit occurs due to foreign matters entering between pins or between the pin and the power supply or the ground pin, the ICs can break down.

(5) Operation in strong electromagnetic field

Be noted that using ICs in the strong electromagnetic field can malfunction them.

(6) Input pins

In terms of the construction of IC, parasitic elements are inevitably formed in relation to potential. The operation of the parasitic element can cause interference with circuit operation, thus resulting in a malfunction and then breakdown of the input pin. Therefore, pay thorough attention not to handle the input pins, such as to apply to the input pins a voltage lower than the ground respectively, so that any parasitic element will operate. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. In addition, even if the power supply voltage is applied, apply to the input pins a voltage lower than the power supply voltage or within the guaranteed value of electrical characteristics.

(7) External capacitor

In order to use a ceramic capacitor as the external capacitor, determine the constant with consideration given to a degradation in the nominal capacitance due to DC bias and changes in the capacitance due to temperature, etc.

(8) Thermal shutdown circuit (TSD)

This LSI builds in a thermal shutdown (TSD) circuit. When junction temperatures become detection temperature or higher, the thermal shutdown circuit operates and turns a switch OFF. The thermal shutdown circuit, which is aimed at isolating the LSI from thermal runaway as much as possible, is not aimed at the protection or guarantee of the LSI. Therefore, do not continuously use the LSI with this circuit operating or use the LSI assuming its operation.

(9) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd) in actual states of use.

(10) LDO

Use each output of LDO by the independence. Don't use under the condition that each output is short-circuited because it has the possibility that an operation becomes unstable.

(11) About the pin for the test, the un-use pin

Prevent a problem from being in the pin for the test and the un-use pin under the state of actual use. Please refer to a function manual and an application notebook. And, as for the pin that doesn't specially have an explanation, ask our company person in charge.

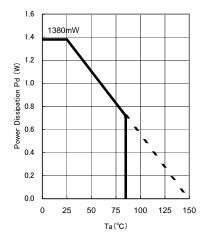
(12) About the rush current

For ICs with more than one power supply, it is possible that rush current may flow instantaneously due to the internal powering sequence and delays. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of wiring.

(13) About the function description or application note or more.

The function description and the application notebook are the design materials to design a set. So, the contents of the materials aren't always guaranteed. Please design application by having fully examination and evaluation include the external elements.

● Power dissipation (On the ROHM's standard board)

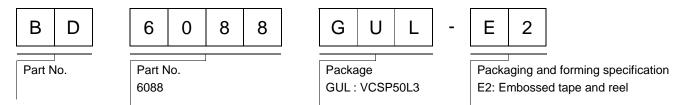


Information of the ROHM's standard board

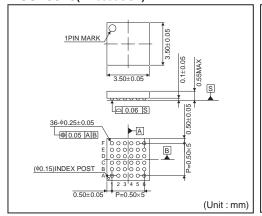
Material: glass-epoxy

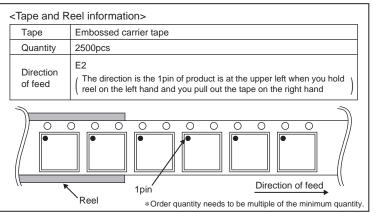
Size: 50mm×58mm×1.75mm(8th layer)
Wiring pattern figure Refer to after page.

Ordering part number



VCSP50L3(BD6088GUL)





Notes

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